

General Description

The MAX3209E is a complete, dual DTE RS-232 serial port (6 transmitters, 10 receivers) for motherboards and desktop PCs that ensures compliance with the stringent ESD requirements of the European Community. The device minimizes board space and power consumption by eliminating the need for a negative power supply; it integrates two serial ports and a charge pump into a single 38-pin TSSOP package.

The MAX3209E features a 50µA low-power standby mode for compliance with system power-management requirements. During standby, while the device operates from the single +3V to +5.5V logic supply, one receiver on each port remains active, allowing automatic system wake-up when peripheral communications resume.

All transmitter outputs and receiver inputs are protected to ±15kV using IEC 1000-4-2 Air-Gap Discharge, ±8kV using IEC 1000-4-2 Contact Discharge, and ±15kV using the Human Body Model, making the device ideal for use in harsh environments or mission-critical equipment. As a result of its robust charge-pump structure, the MAX3209E guarantees mouse driveability and true RS-232 operation at data rates up to 460kbps, ensuring compatibility with PC-to-PC communication software (such as LapLink™).

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX3209ECUU	0°C to +70°C	38 TSSOP
MAX3209EEUU	-40°C to +85°C	38 TSSOP

Applications

Desktop PCs

Motherboards

Instruments

Equipment Requiring IEC 1000-4-2 Compliance

Telecommunications

Network Servers

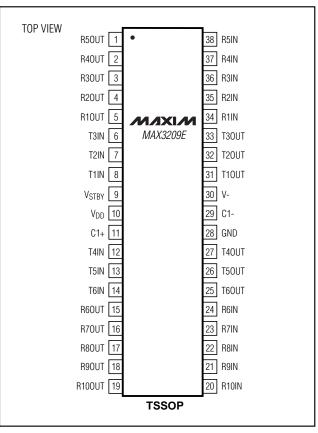
Typical Operating Circuit appears at end of data sheet.

LapLink is a trademark of Traveling Software.

Features

- ◆ Two Complete Serial Ports in a Single 38-Pin **TSSOP Package**
- ♦ Requires Only +12V Supply and Logic Supply (+3V to +5.5V)
- ♦ No Negative Supply Required
- **♦** One Receiver Active per Port in Standby for System Wake-Up
- ♦ 460kbps Data Rate; LapLink Compatible
- ♦ Enhanced ESD Protection ±15kV—Human Body Model ±8kV—IEC 1000-4-2, Contact Discharge ±15kV—IEC 1000-4-2, Air-Gap Discharge
- ♦ Low 50µA Standby Current
- ♦ Operates with Either +3V or +5V Logic
- **♦** Guaranteed Mouse Driveability
- ♦ Small 0.1µF Capacitors
- **♦ Flow-Through Pinout**

Pin Configuration



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

V _{DD}	0.3V to +15V
VSTBY	0.3V to +7V
V	+0.3V to -15V
Input Voltages	
T_IN	0.3V to +7V
R_IN	±30V
Output Voltages	
T_OUT	±15V
R_OUT	0.3V to (V _{STBY} + 0.3V)

Short-Circuit Duration	
T_OUT (one at a time)	Continuous
R_OUT (one at a time)	Continuous
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
TSSOP (derate 11.8mW/°C above +70°C)	941mW
Operating Temperature Ranges	
MAX3209EC	0°C to +70°C
MAX3209EE	40°C to +85°C
Storage Temperature Range	
Lead Temperature (soldering, 10sec)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +10.8V \text{ to } +13.2V, V_{STBY} = +3V \text{ to } +5.5V, C1 = C2 = 0.1 \mu\text{F}, T_{A} = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$ Typical values are at $T_{A} = +25^{\circ}\text{C}, V_{DD} = +12V, V_{STBY} = +3.3V.)$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC CHARACTERISTICS	-1	·		ı			
Operating Voltage Denge	V _{DD}			10.8		13.2	V
Operating Voltage Range	STBY			3		5.5	V
Cumply Current	I _{DD}	V _{DD} = +12V, no load, all transmitter inputs at V _{STBY} , all receiver inputs at V _{STBY} or unconnected			0.5	1	mA
Supply Current	ISTBY	V _{DD} = 0, V _{STBY} = +3.3V, no load, all transmitter inputs at V _{STBY} , all receiver inputs at V _{STBY} or unconnected			50	100	μΑ
TRANSMITTER LOGIC INPUTS	1			1			1
Input Logic Threshold Low	VILT	T_IN				0.8	V
Input Logic Threshold High	VIHT	T_IN		2			V
Input Pull-Up Current		Transmitter input at GN	ND			25	μΑ
RECEIVER LOGIC OUTPUTS	1						
Output Voltage Low	Volr	R_OUT; I _{SINK} = 1.6mA				0.4	V
Output Voltage High	Vohr	R_OUT	ISOURCE = 40µA	V _{STBY} - 0	.3		V
Output Voltage Flight	VOHR	I _{SOURCE} = 1mA		V _{STBY} - 0	.6		·
Receiver Output Leakage Current		V _{DD} = 0, V _{STBY} = 5V			0.05	±5	μΑ
RS-232 TRANSMITTER OUTPU	ITS	L					
Output Voltage Swing		All transmitter outputs loaded with $3k\Omega$ to GND		±5.0			V
RS-232 Output Short-Circuit Current		V _{T_OUT} = 0			±10	±60	mA
Transmitter Output Resistance		$V_{DD} = V_{STBY} = 0, V_{OUT} = \pm 2V$		300			Ω
RS-232 RECEIVER INPUTS	L	l		L			1
Receiver Input Voltage Range				-25		25	V
RS-232 Input Threshold Low		T _A = +25°C				0.4	V
RS-232 Input Threshold High		T _A = +25°C		2.4			V
RS-232 Input Hysteresis		V _{STBY} = 3.3V		0.2		1	V
RS-232 Input Resistance		T _A = +25°C		3	5	7	kΩ

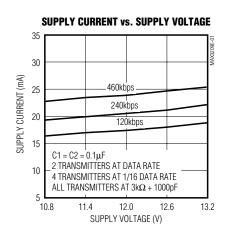
ELECTRICAL CHARACTERISTICS (continued)

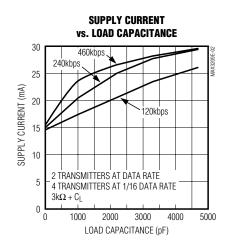
 $(V_{DD} = +10.8V \text{ to } +13.2V, V_{STBY} = +3V \text{ to } +5.5V, C1 = C2 = 0.1 \mu F, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C, V_{DD} = +12V, V_{STBY} = +3.3V.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ESD CHARACTERISTICS						
		Human Body Model		±15		
ESD Protection		IEC 1000-4-2 (Contact Discharge)		±8		kV
		IEC 1000-4-2 (Air-Gap Discharge)		±15		
TRANSMITTER TIMING CHARA	CTERISTIC	S (Figure 1)				
Guaranteed Data Rate	DR	$R_L = 3k\Omega$ to $7k\Omega$, $C_L = 50pF$ to 1000pF, two transmitters switching	460			kbps
Mouse Driveability		T1IN = T2IN = GND, T3IN = V _{CC} , T3OUT loaded with $3k\Omega$ to GND, T1OUT and T2OUT loaded with 2.5mA each	+6		-5	V
Transmitter Output Propagation Delay, Low to High	tpLHT	C _L = 1000pF		1		μs
Transmitter Output Propagation Delay, High to Low	tPHLT	C _L = 1000pF		1		μs
Transmitter Output Slew Rate	SR	$\begin{array}{ll} R_L=3k\Omega \ \text{to} \ 7k\Omega, \ V_{STBY}=3.3V, \\ C_L=50 \text{pF to} \ 1000 \text{pF}, \ T_A=+25 ^{\circ}\text{C}, \\ \text{measured from} \ +3V \ \text{to} \ -3V \ \text{or} \ -3V \ \text{to} \ +3V \\ \end{array} \qquad \qquad \begin{array}{ll} 6 & 12 \\ \end{array}$		30	V/µs	
RECEIVER TIMING CHARACTE	RISTICS					
Receiver Output Propagation Delay, Low to High	tplhr	$C_L = 150pF$ 0.4		1	μs	
Receiver Output Propagation Delay, High to Low	tphlr	C _L = 150pF 0.4		1	μs	

Typical Operating Characteristics

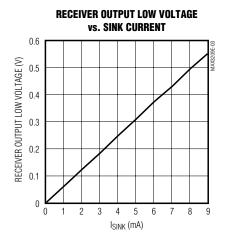
(VSTBY = +5V, VDD = +12V, C1 = C2 = 0.1μ F, TA = $+25^{\circ}$ C, unless otherwise noted.)

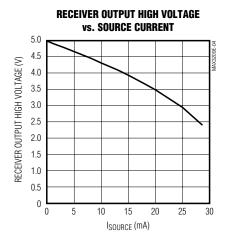




Typical Operating Characteristics (continued)

(V_{STBY} = +5V, V_{DD} = +12V, C1 = C2 = 0.1μ F, T_A = +25°C, unless otherwise noted.)





Pin Description

PIN	NAME	FUNCTION	
1–5, 15–19	R_OUT	TTL/CMOS Receiver Outputs	
6, 7, 8, 12, 13, 14	T_IN	TTL/CMOS Transmitter Inputs	
9	V _{STBY}	Standby Power Supply for R5 and R10	
10	V_{DD}	+12V Single-Supply Voltage	
11	C1+	Positive Terminal of the Inverting Charge-Pump Capacitor	
20–24, 34–38	R_IN	RS-232 Receiver Inputs	
25, 26, 27, 31, 32, 33	T_OUT	RS-232 Transmitter Outputs	
28	GND	Ground	
29	C1-	Negative Terminal of the Inverting Charge-Pump Capacitor	
30	V-	-12V generated by the inverting charge pump	

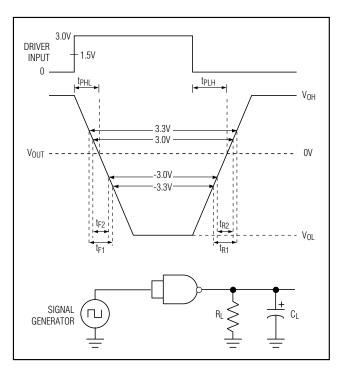


Figure 1. Slew-Rate Test Circuit and Timing Diagram

Detailed Description

±15kV ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges (ESD) encountered during handling and assembly. The MAX3209E driver outputs and receiver inputs have extra protection against static electricity found in normal operation. Maxim's engineers developed state-of-the-art structures to protect these pins against ±15kV ESD, without damage. After an ESD event, the MAX3209E continues working without latchup. ESD protection can be tested in several ways. The

ESD protection can be tested in several ways. The transmitter outputs and receiver inputs are characterized for protection to the following:

- 1) ±15kV using the Human Body Model
- 2) ±8kV using the Contact-Discharge Method specified in IEC 1000-4-2 (formerly IEC 801-2)
- 3) ±15kV using the Air-Gap Method specified in IEC 1000-4-2 (formerly IEC 801-2)

ESD Test Conditions

ESD performance depends on a number of conditions. Contact Maxim for a reliability report that documents test setup, methodology, and results.

Human Body Model

Figure 2a shows the Human Body Model, and Figure 2b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the device through a 1.5k Ω resistor.

IEC 1000-4-2

Since January 1996, all equipment manufactured and/or sold in the European community has been required to meet the stringent IEC 1000-4-2 specification. The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits. The MAX3209E helps you design equipment that meets Level 4 (the highest level) of IEC 1000-4-2, without additional ESD-protection components.

The main difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2. Because series resistance is lower in the IEC 1000-4-2 ESD test model (Figure 3a), the ESD withstand voltage measured to this standard is generally lower than that measured using the Human Body Model. Figure 3b shows the current waveform for the ±8kV IEC 1000-4-2 Level 4 ESD Contact-Discharge test.

The Air-Gap test involves approaching the device with a charge probe. The Contact-Discharge method connects the probe to the device before the probe is energized.

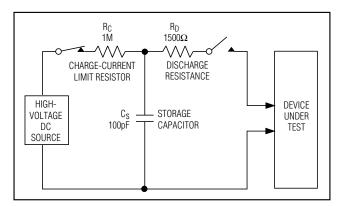


Figure 2a. Human Body ESD Test Model

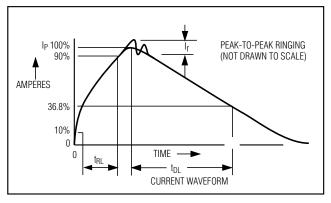


Figure 2b. Human Body Model Current Waveform

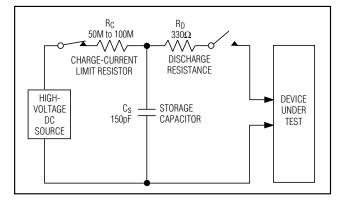


Figure 3a. IEC 1000-4-2 ESD Test Model

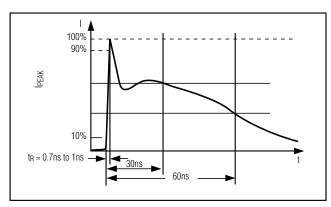


Figure 3b. IEC 1000-4-2 ESD-Generator Current Waveform

Machine Model

The Machine Model for ESD testing uses a 200pF storage capacitor and zero-discharge resistance. It mimics the stress caused by handling during manufacturing and assembly. Of course, all pins (not just RS-232 inputs and outputs) require this protection during manufacturing. Therefore, the Machine Model is less relevant to the I/O ports than are the Human Body Model and IEC 1000-4-2.

Applications Information

R5 and R10 Active in Standby Mode

The MAX3209E is placed in standby mode when V_{DD} is not present, provided that V_{STBY} remains at +3V to +5.5V. In standby mode, receivers R5 and R10 remain active, consuming 100 μ A max while unloaded. Standby mode allows activity to be sensed on the serial ports so that main power can be restored by the power-management unit, as shown in Figure 4.

Layout Considerations

Use proper layout to ensure other devices on your board are not damaged in an ESD strike. Currents as high as 60A can instantaneously pass into ground, so be sure to minimize the ground-lead return path to the power supply. A separate return path to the power supply is recommend. Trace widths should be greater than 40 mils. Bypass V_{DD} and V_{STBY} with $0.1\mu F$ capacitors as close to the part as possible to ensure maximum ESD protection.

The MAX3209E is not sensitive to power-supply sequencing, and therefore requires no external protection diodes.

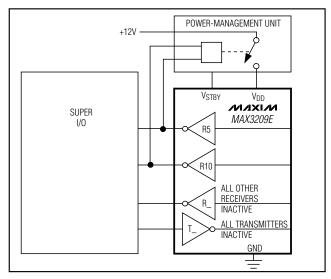


Figure 4. MAX3209E in Standby Mode

Interconnection with 3V and 5V Logic

The MAX3209E can directly interface with various 3V and 5V logic families, including ACT and HCT CMOS. See Table 1 for more information on possible combinations of interconnections.

Mouse Driveability

The MAX3209E has been specifically designed to power serial mice while operating from low-voltage power supplies. It has been tested with leading mouse brands from manufacturers such as Microsoft and Logitech. The MAX3209E successfully drove all serial mice tested and met their respective current and voltage requirements.

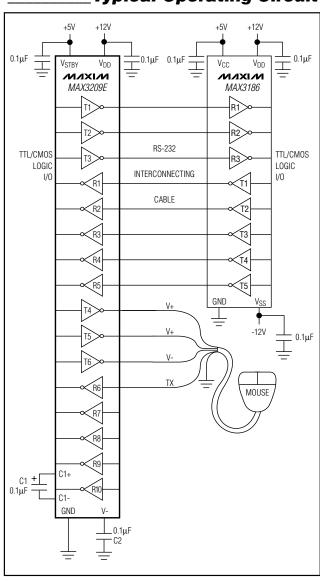
Table 1. Logic Family Compatibility with Various Supply Voltages

SYSTEM POWER- SUPPLY VOLTAGE (V)	V _{STBY} SUPPLY VOLTAGE (V)	COMPATIBILITY
3.3	3.3	Compatible with all CMOS families.
5	5	Compatible with all TTL and CMOS families.
5	3.3	Compatible with ACT and HCT CMOS, and with AC, HC, or CD4000 CMOS.

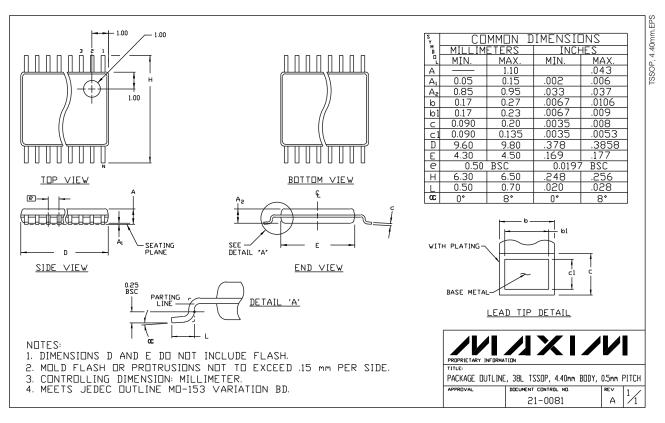
Typical Operating Circuit

Chip Information

TRANSISTOR COUNT: 774



Package Information



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.